TITLE

ORGANIC ELECTRONIC DEVICES WITH LOW THERMAL RESISTANCE AND PROCESSES FOR FORMING AND USING THE SAME

ABSTRACT OF THE INVENTION

An aspect of the present invention provides an organic electronic device includes a heat sink having a side with a roughened surface and/or a black surface and a process for forming devices having such heat sinks including forming a patterned electrically conductive layer includes an electrically conductive member. The process includes selectively forming spaced-apart members. The heat sink includes the spaced-apart members, which are spaced apart from each other and thermally coupled to the electrically conductive member.